

UNISONIC TECHNOLOGIES CO., LTD

3N70 **Power MOSFET**

3 AMPS, 700 VOLTS N-CHANNEL POWER MOSFET

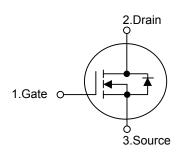
DESCRIPTION

The UTC 3N70 is a high voltage and high current power MOSFET, designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in power supplies, PWM motor controls, high efficient DC to DC converters and bridge circuits.

FEATURES

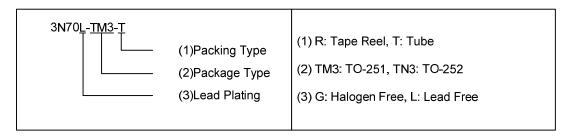
- * $R_{DS(ON)} \le 4.0\Omega$ @ $V_{GS} = 10 \text{ V}$
- * Ultra low gate charge (typical 10 nC)
- * Low reverse transfer capacitance
- * Fast switching capability
- * Avalanche energy specified
- * Improved dv/dt capability, high ruggedness

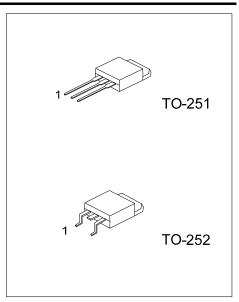
SYMBOL



ORDERING INFORMATION

Ordering Number		Dookogo	Pin Assignment			Dooking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
3N70L-TM3-T	3N70G-TM3-T	TO-251	G	D	S	Tube	
3N70L-TN3-R	3N70G-TN3-R	TO-252	G	D	S	Tape Reel	





www.unisonic.com.tw 1 of 6

■ ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V _{DSS}	700	V
Gate-Source Voltage		V_{GSS}	±30	V
Avalanche Current (Note 2)		I _{AR}	3.0	Α
Continuous Drain Current		I _D	3.0	Α
Pulsed Drain Current (Note 2)		I _{DM}	12	Α
Avalanche Energy	Single Pulsed (Note 3)	E _{AS}	200	mJ
	Repetitive (Note 2)	E _{AR}	7.5	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.5	V/ns
Power Dissipation		P_D	50	W
Junction Temperature		T_J	+150	°C
Operating Temperature		T _{OPR}	-55 ~ + 150	°C
Storage Temperature		T _{STG}	-55 ~ + 150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature
- 3. L = 64mH, I_{AS} = 2.4A, V_{DD} = 50V, R_{G} = 25 Ω , Starting T_{J} = 25°C
- 4. $I_{SD} \le 3.0A$, di/dt $\le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25$ °C

■ THERMAL DATA

PARAMETER	SYMBOL	RATING	UNIT
Junction to Ambient	θ_{JA}	110	°C/W
Junction to Case	θ_{JC}	2.5	°C/W

■ **ELECTRICAL CHARACTERISTICS** (T_C =25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
OFF CHARACTERISTICS								
Drain-Source Breakdown Voltage		BV _{DSS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	700			V	
Drain-Source Leakage Current		I _{DSS}	V _{DS} = 700 V, V _{GS} = 0 V			10	μΑ	
Gate-Source Leakage Current	Forward	- I _{GSS}	$V_{GS} = 30 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA	
	Reverse		V _{GS} = -30 V, V _{DS} = 0 V			-100	nA	
Breakdown Voltage Temperature		△BV _{DSS} /△T _J	I _D = 250μA, Referenced to 25°C		0.6		V/°C	
Coefficient								
ON CHARACTERISTICS		T	T	ı	ı		1	
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.0		4.0	V	
Static Drain-Source On-State Resistance		R _{DS(ON)}	$V_{GS} = 10 \text{ V}, I_D = 1.5 \text{A}$		2.8	4.0	Ω	
DYNAMIC CHARACTERISTICS								
Input Capacitance		C _{ISS}			350	450	pF	
Output Capacitance		Coss	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{MHz}$		50	65	pF	
Reverse Transfer Capacitance		C_{RSS}			5.5	32	pF	
SWITCHING CHARACTERISTIC	S							
Turn-On Delay Time		t _{D(ON)}			10	40	ns	
Turn-On Rise Time		t _R	$V_{DD} = 30V, I_D = 1.0 A, R_G = 25\Omega$		30	70	ns	
Turn-Off Delay Time		t _{D(OFF)}	(Note 1, 2)		20	100	ns	
Turn-Off Fall Time		t _F			30	70	ns	
Total Gate Charge		Q_{G}	V _{DS} = 480V,I _D = 3.0A, V _{GS} = 10 V		10	13	nC	
Gate-Source Charge		Q_{GS}	(Note 1, 2)		2.7		nC	
Gate-Drain Charge		Q_{DD}	(Note 1, 2) 4.9				nC	

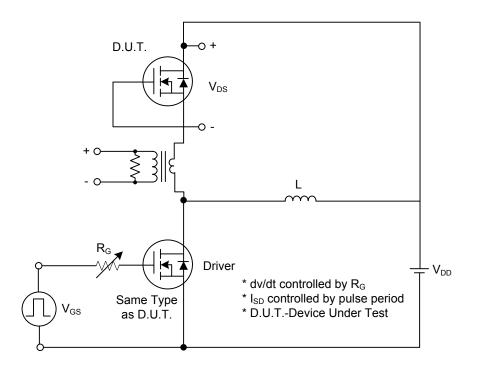
■ ELECTRICAL CHARACTERISTICS(Cont.)

SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS								
Drain-Source Diode Forward Voltage	V_{SD}	$V_{GS} = 0 \text{ V}, I_{S} = 3.0 \text{ A}$			1.4	V		
Maximum Continuous Drain-Source Diode					3.0	^		
Forward Current	IS				3.0	А		
Maximum Pulsed Drain-Source Diode					40	۸		
Forward Current	Ism				12	А		
Reverse Recovery Time	t_RR	$V_{GS} = 0 \text{ V}, I_{S} = 3.0 \text{ A},$		210		ns		
Reverse Recovery Charge	Q_{RR}	$dI_F/dt = 100 A/\mu s \text{ (Note 1)}$		1.2		μC		

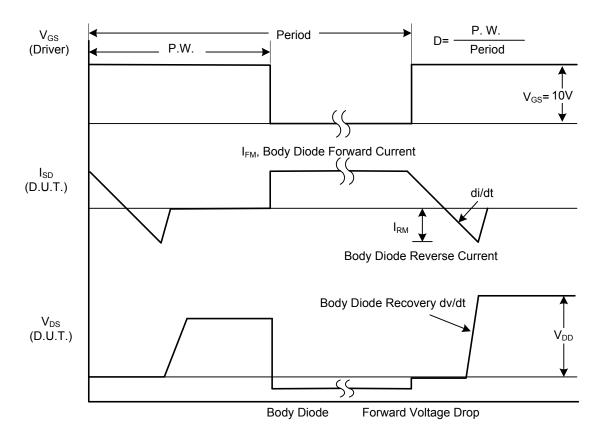
Notes: 1. Pulse Test: Pulse width≤300µs, Duty cycle≤2%

2. Essentially independent of operating temperature

■ TEST CIRCUITS AND WAVEFORMS

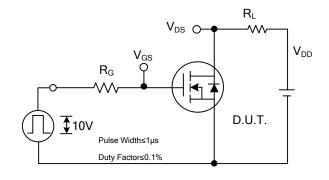


1A Peak Diode Recovery dv/dt Test Circuit



1B Peak Diode Recovery dv/dt Waveforms

■ TEST CIRCUITS AND WAVEFORMS (Cont.)



V_{DS} 90%

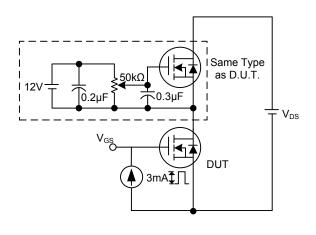
V_{GS} 10%

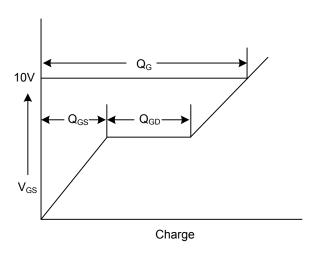
t_{D(ON)}

t_R → t_R ← t_F →

2A Switching Test Circuit

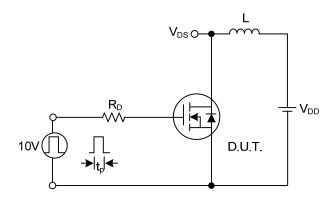
2B Switching Waveforms

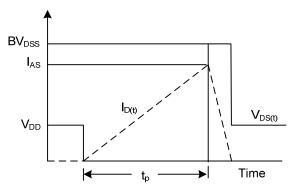




3A Gate Charge Test Circuit

3B Gate Charge Waveform

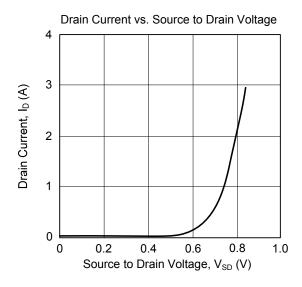


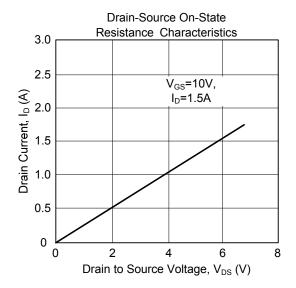


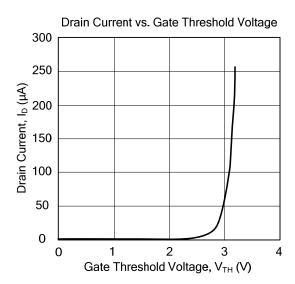
4A Unclamped Inductive Switching Test Circuit

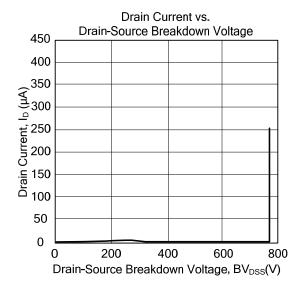
4B Unclamped Inductive Switching Waveforms

■ TYPICAL CHARACTERISTICS









UTC assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all UTC products described or contained herein. UTC products are not designed for use in life support appliances, devices or systems where malfunction of these products can be reasonably expected to result in personal injury. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner. The information presented in this document does not form part of any quotation or contract, is believed to be accurate and reliable and may be changed without notice.